

Reverse Diode Characteristics:

| Characteristics | Symbol | Condition | Typ. | Max. | Units |
|----------------------------------|----------|---|------|------|-------|
| Diode Forward Voltage | V_{SD} | $V_{GS} = -5 \text{ V}$, $I_{SD} = 6.7 \text{ A}$ | 3.7 | | V |
| | V_{SD} | $V_{GS} = -5 \text{ V}$, $I_{SD} = 6.7 \text{ A}$, $T_J = 175 \text{ }^\circ\text{C}$ | 3.3 | | V |
| Continuous Diode Forward Current | I_S | $V_{GS} = -5 \text{ V}$, $T_C = 25 \text{ }^\circ\text{C}$ | 20 | | A |
| Reverse Recovery Time | t_{rr} | $V_{GS} = -5 \text{ V}$, $I_{SD} = 13.3 \text{ A}$, $T_J = 25 \text{ }^\circ\text{C}$ | 7.3 | | ns |
| Reverse Recovery Charge | Q_{rr} | | 0.05 | | uC |
| Peak Reverse Recovery Current | I_{mm} | $V_R = 800 \text{ V}$ $dif/dt = 3030 \text{ A}/\mu\text{s}$ | 11.9 | | A |

Thermal-Mechanical Specifications:

| Characteristics | Symbol | Condition | Specification | Units |
|---|------------|--------------|---------------|---------------------------|
| Junction Temperature | T_J | - | -55 to +175 | $^\circ\text{C}$ |
| Storage Temperature | T_{stg} | - | -55 to +175 | $^\circ\text{C}$ |
| Typical Thermal Resistance Junction to Case | R_{thJC} | DC operation | 0.96 | $^\circ\text{C}/\text{W}$ |

Ordering Information:

| Device | Package | Shipping |
|-------------|---------|--------------|
| S2M0120120T | TOLL | 1800pcs/Reel |

Marking Diagram

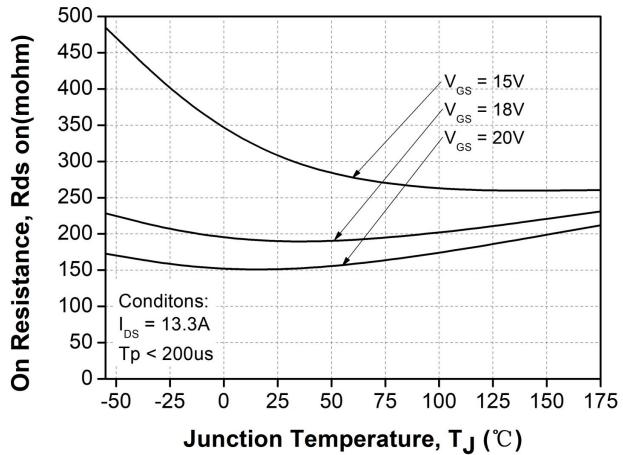
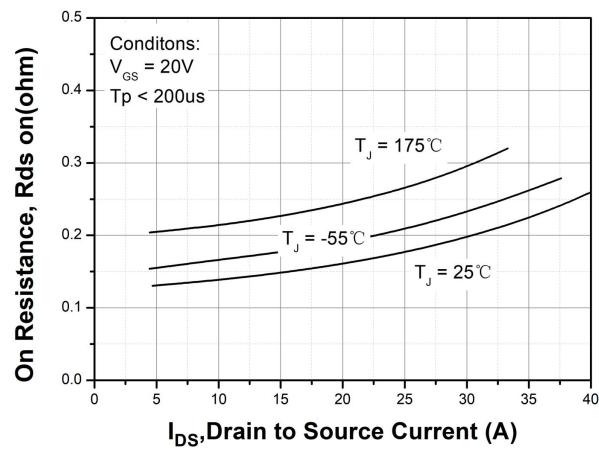
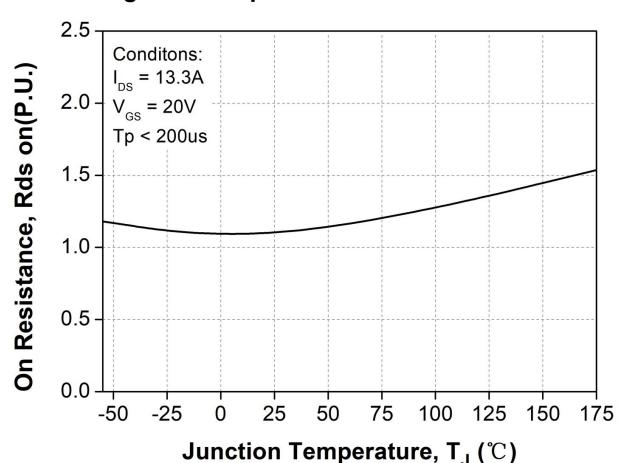
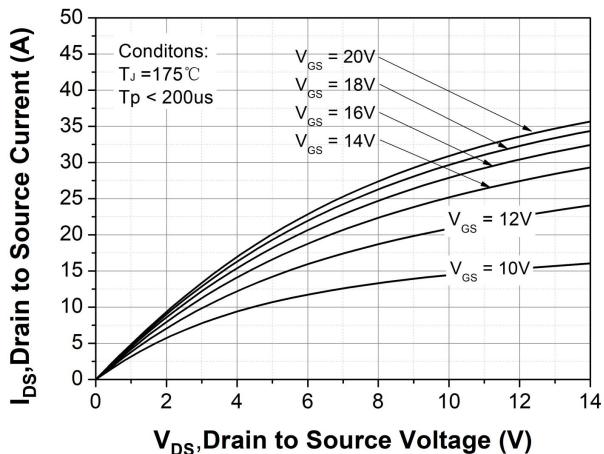
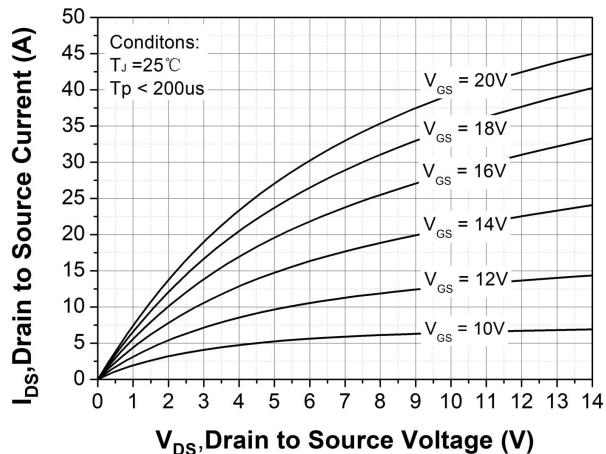
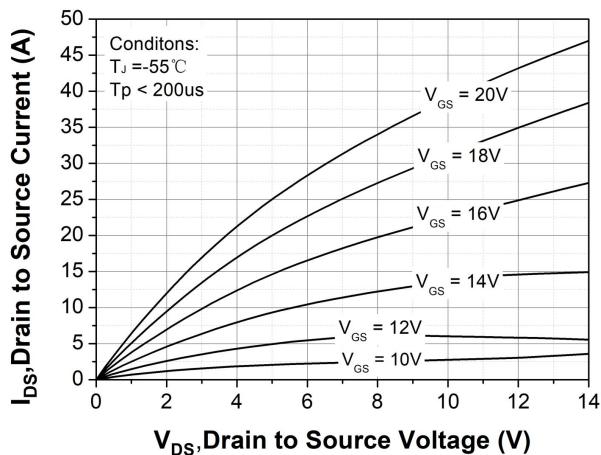


Where XXXXX is YYWWL

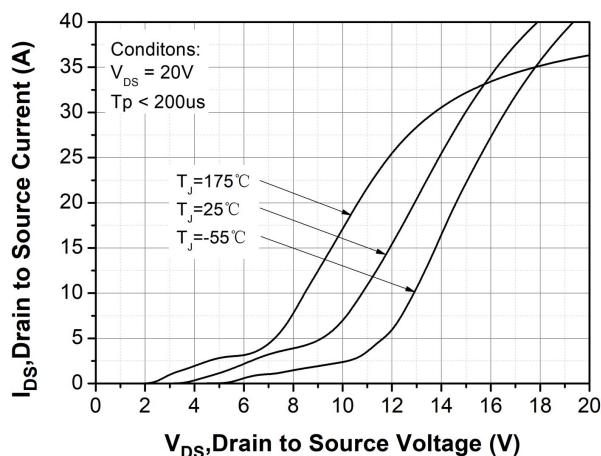
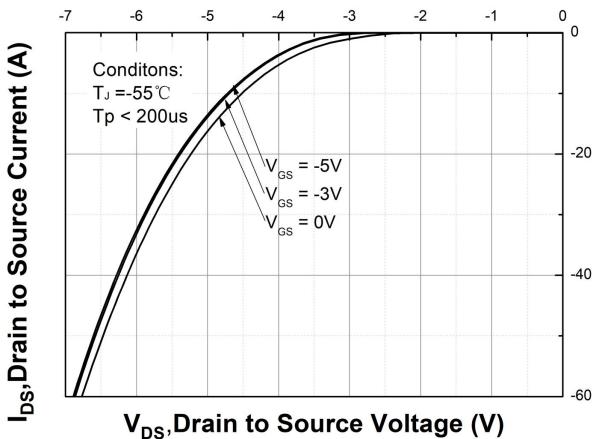
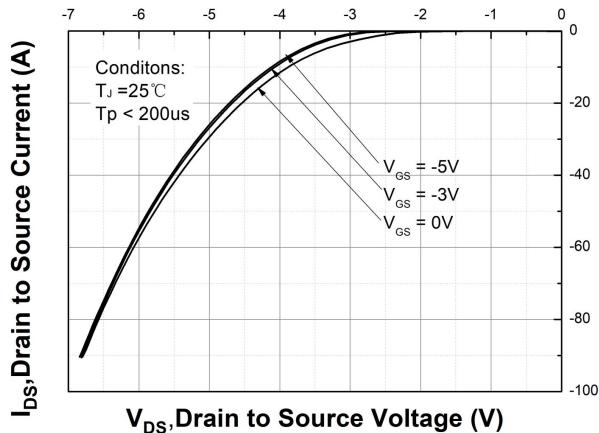
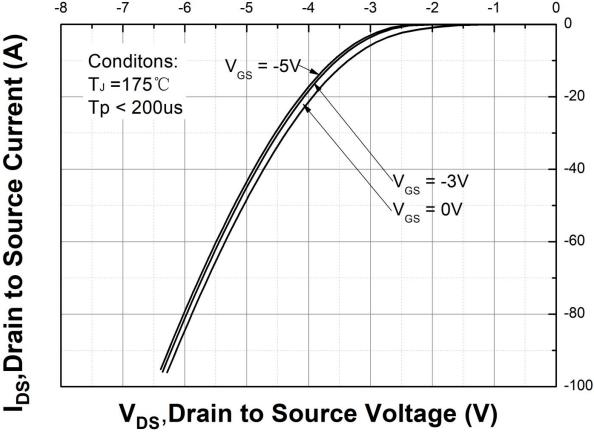
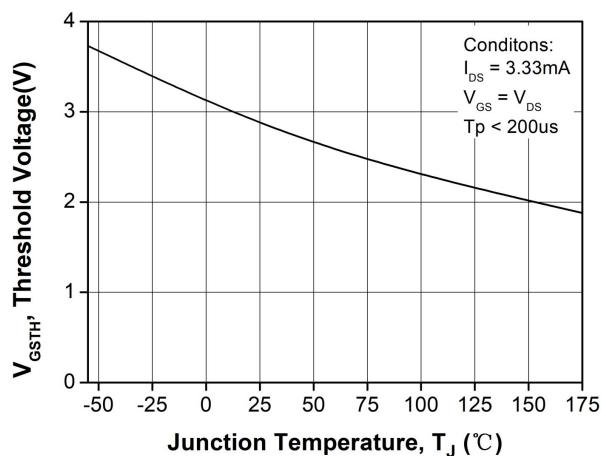
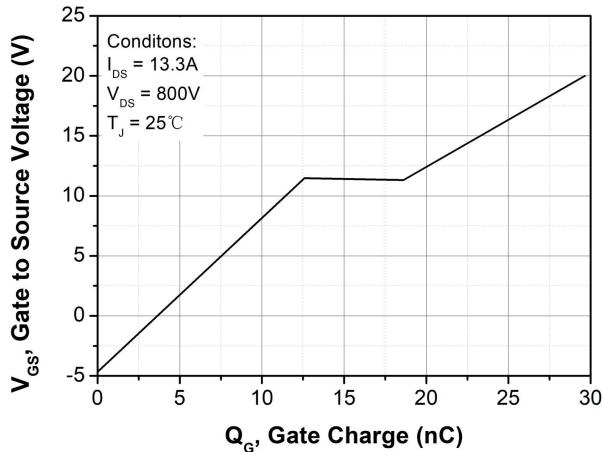
S2M = Device Type
 0120 = $R_{DS(on)}$
 120 = Reverse Voltage (1200V)
 T = Package
 SSG = SSG
 YY = Year
 WW = Week
 L = Lot Number

Cautions: Molding resin
Epoxy resin UL:94V-0

Ratings and Characteristics Curves



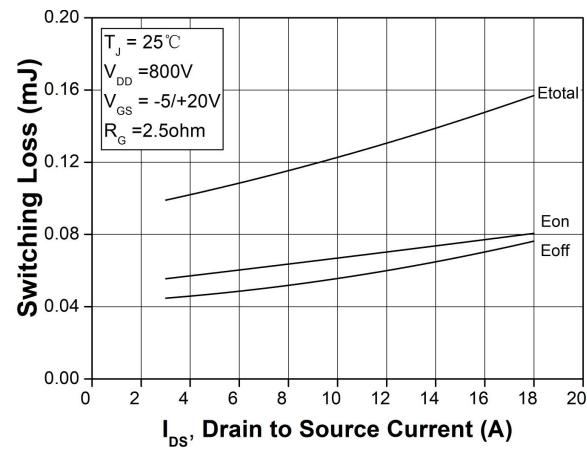
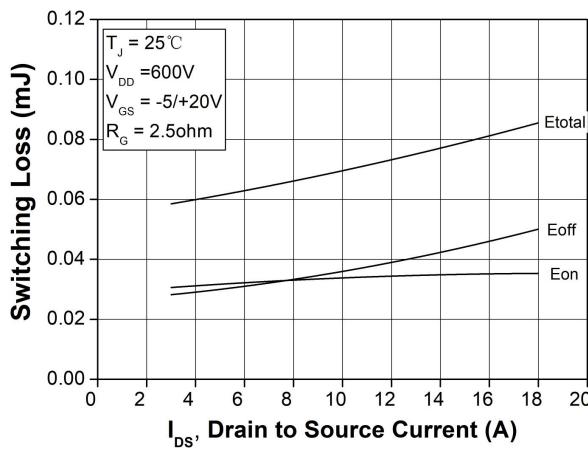
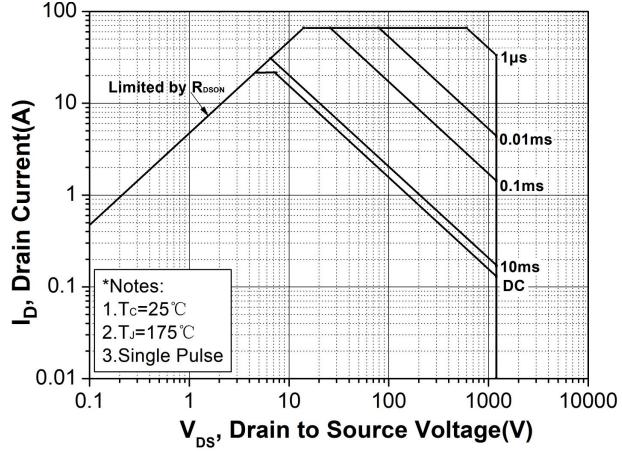
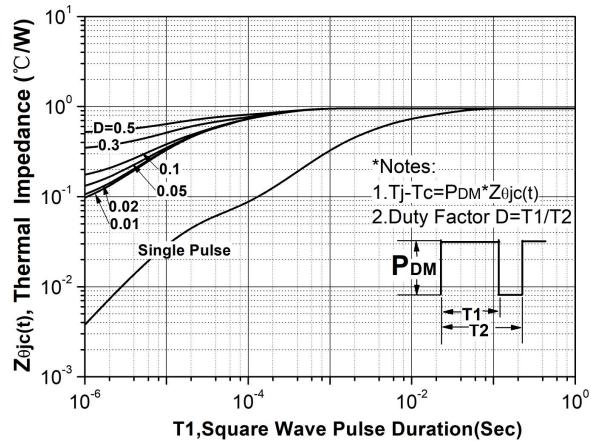
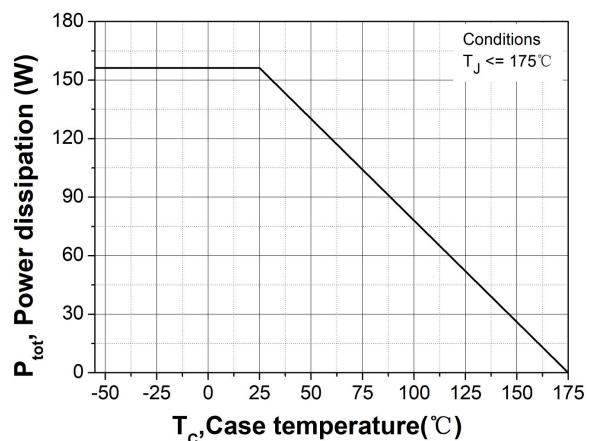
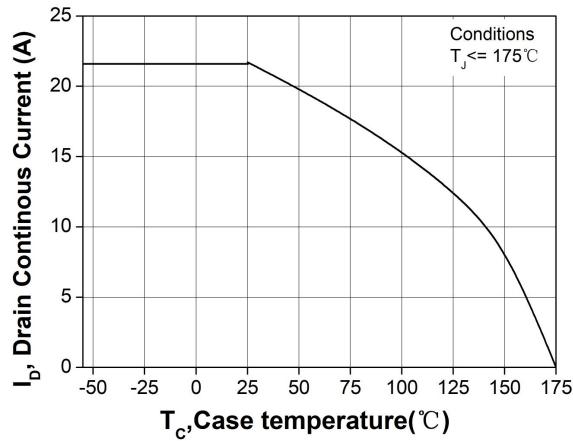
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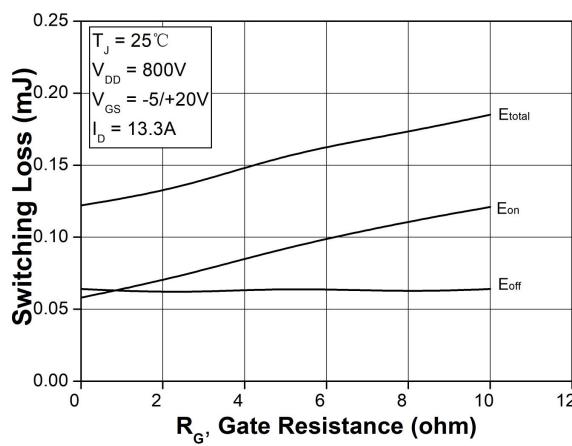
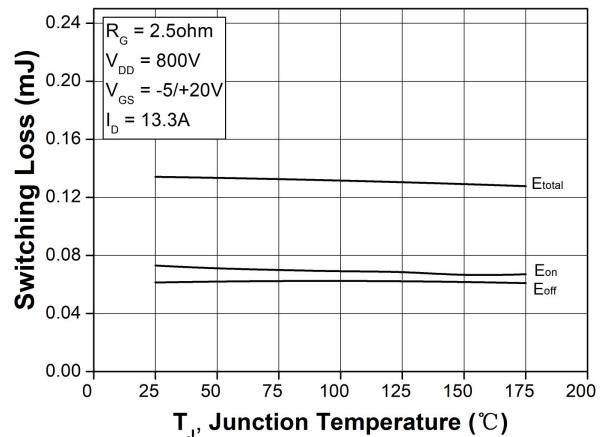
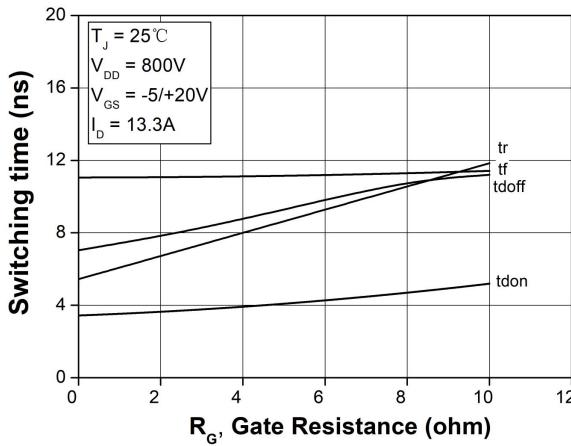
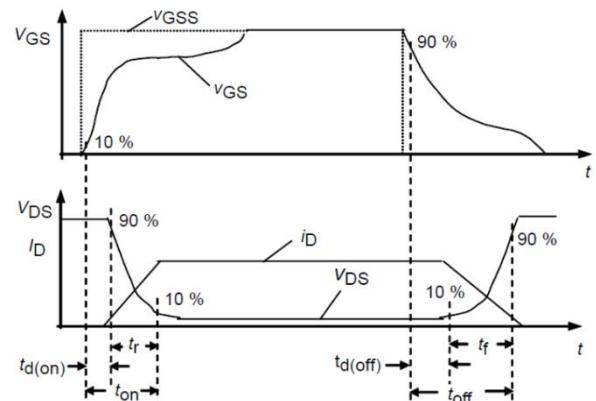
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Figure 7. Transfer Characteristic for Various Junction Temperatures

Figure 8. Body Diode Characteristic at $T_J = -55^\circ C$

Figure 9. Body Diode Characteristic at $T_J = 25^\circ C$

Figure 10. Body Diode Characteristic at $T_J = 175^\circ C$

Figure 11. Threshold Voltage vs. Temperature

Figure 12. Gate Charge Characteristic

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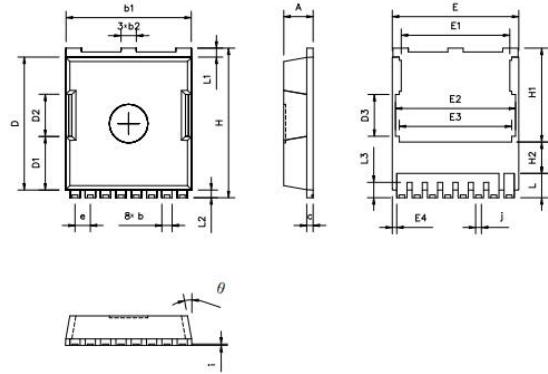
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Figure 25. Clamped Inductive Switching Energy vs. $R_{G(\text{ext})}$

Figure 26. Clamped Inductive Switching Energy vs. Temperature

Figure 27. Switching Times vs. $R_{G(\text{ext})}$

Figure 28. Switching Times Definition

Mechanical Dimensions TOLL



| SYMBOL | Dimensions In Millimeters | | |
|--------|---------------------------|------------|-------|
| | Min. | NOM. | Max. |
| A | 2.20 | 2.30 | 2.40 |
| b | 0.70 | 0.80 | 0.90 |
| b1 | 9.70 | 9.80 | 9.90 |
| b2 | | 1.20 REF. | |
| c | 0.40 | 0.50 | 0.60 |
| D | 10.28 | 10.38 | 10.48 |
| D1 | 4.08 | 4.18 | 4.28 |
| D2 | 3.20 | 3.30 | 3.40 |
| D3 | 3.16 | 3.26 | 3.36 |
| E | 9.80 | 9.90 | 10.00 |
| E1 | 8.40 | 8.50 | 8.60 |
| E2 | 9.30 | 9.40 | 9.50 |
| E3 | | 8.8 REF. | |
| E4 | 0.25 | 0.35 | 0.45 |
| e | | 1.20 BASIC | |
| H | 11.58 | 11.68 | 11.78 |
| H1 | 7.23 | 7.33 | 7.43 |
| H2 | | 2.45 REF. | |
| i | 0.10 | - | - |
| j | | 0.45REF. | |
| L | 1.60 | 1.90 | 2.10 |
| L1 | 0.60 | 0.70 | 0.80 |
| L2 | 0.50 | 0.60 | 0.70 |
| L3 | 1.05 | 1.20 | 1.30 |
| e | | 10° REF. | |



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